

## Freescale Semiconductor, Inc.

Thermal Measurement Report DATE: 5/8/96

revised 11/18/96

Package Description: Package: 240 32 x 32 mm QFP

Die Down

Flag: 10.6 mm Square Leadframe: SIDN 1234625 Die Attach: JMI 2500AN

Mold Compound: Sumitomo 7304LC

Assembled: ANAM

Die: PST6 - 10.16 mm Square

Junction to Ambient Thermal Resistance or Theta JA (R JA) was measured per SEMI Test Method G38-87 at 1.5 watts in a horizontal configuration. The test board conforms to EIA/JESD 51-3; it is a single layer 115x102 mm board designed to test 0.5 mm pitch QFP packages from 208 to 304 leads. The trace width is 0.24 mm, trace thickness is 0.076 mm. Sample size was 5.

Convection	Theta JA Average °C/watt	Standard Deviation °C/watt	Theta JA Ave + 3 Std. Dev. °C/watt
Natural	31.0	0.08	31.3
100 ft/min	27.7	0.18	28.3
200	26.1	0.1	26.4
400	23.7	0.34	24.7
800	19.9	0.11	20.2

"Thermal resistance" from junction to a thermocouple on top center of case, previously titled Theta J-Ref (R JR), was been renamed by the industry standard committee JEDEC JC15.1 as JT and defined in EIA/JESD51-2. It is a useful value to use to estimate junction temperature in steady state customer environments.

Convection	JT	Standard
	Average	Deviation
	°C/watt	°C/watt
Natural	1.9	0.09
100 ft/min	2.3	0.06
200	2.5	0.04
400	3.1	0.08
800	3.9	0.1





#### Freescale Semiconductor, Inc.

Junction to case thermal resistance, Theta JC (R JC), was measured using the cold plate technique with the cold plate temperature used as the "case" temperature. The reference specifications are MIL-STD 883D, Method 1012.1 and SEMI G30-88. Sample size was 5.

Theta JC	Standard	Theta JC
Average	Deviation	Ave + 3 Std. Dev.
°C/watt	°C/watt	°C/watt
8.9	0.07	9.1

Junction to board thermal resistance Theta JB (R JB) was measured using a cold plate technique with the cold plate in thermal contact with the bottom of the printed circuit board. The board temperature was measured with a thermocouple soldered to a center lead along one side of the package where the lead was soldered to the board. The measurement was taken using the 4 conductor layer printed circuit board described below. Sample size is 5.

Theta JB	Standard	Theta JB	
Average	Deviation	Ave + 3 Std. Dev.	
°C/watt	°C/watt	°C/watt	
18.8	0.19	19.4	

Junction to Ambient Thermal Resistance (Theta JA) was also measured on a four layer test board. The test board was a 115x102 mm board designed to test 0.5 mm pitch QFP packages from 208 to 304 leads with two solid internal plane of 1 oz nominal thickness (0.033 mm thick). The trace pattern on the component side had a trace width of 0.231 mm, trace thickness of 0.0715 mm. Sample size was 5.

Do Not Use this data without special footnote indicating that the results were measured on a board with two solid internal planes.

Convection	Theta JA	Standard	Theta JA
	Average	Deviation	Ave + 3 Std. Dev.
	°C/watt	°C/watt	°C/watt
Natural	26.1	0.11	26.4
100 ft/min	23.8	0.13	24.2
200	22.8	0.13	23.2
400	21.3	0.19	21.9
800	18.6	0.16	19.1

SEMI specifications are available from Semiconductor Equipment and Materials International at (415) 964-5111.

MIL-SPEC and EIA/JESD (JEDEC) specifications are available from Global Engineering Documents at 800-854-7179 or 303-397-7956.



### Freescale Semiconductor, Inc.

From Bennett Joiner Ruth Reinhardt EMAIL Phone RXMN60 512-933-7597 RBDT20 512-933-6407

FAX 7 512-933-6344 7 512-933-6344

Home Page: www.freescale.com email:

support@freescale.com

USA/Europe or Locations Not Listed:

Freescale Semiconductor Technical Information Center, CH370 1300 N. Alma School Road Chandler, Arizona 85224 (800) 521-6274 480-768-2130 support@freescale.com

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH

Technical Information Center

Schatzbogen 7

81829 Muenchen, Germany

+44 1296 380 456 (English) +46 8 52200080 (English)

+49 89 92103 559 (German)

+33 1 69 35 48 48 (French)

support@freescale.com

Japan:

Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku Tokyo 153-0064, Japan 0120 191014 +81 2666 8080

support.japan@freescale.com

Asia/Pacific: Freescale Semiconductor Hong Kong Ltd.

Technical Information Center 2 Dai King Street

Tai Po Industrial Estate,

Tai Po, N.T., Hong Kong

+800 2666 8080

support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center

P.O. Box 5405

Denver, Colorado 80217

(800) 441-2447 303-675-2140 Fax: 303-675-2150

LDCForFreescaleSemiconductor

@hibbertgroup.com

RoHS-compliant and/or Pb- free versions of Freescale products have the functionality and electrical characteristics of their non-RoHS-compliant and/or non-Pb- free counterparts. For further information, see http://www.freescale.com or contact your Freescale sales representative.

For information on Freescale.s Environmental Products program, go to http://www.freescale.com/epp.

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document. Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all laking parts demonstrated application. claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.



# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

#### NXP:

MC68EN360ZP25VL MC68EN360VR25VL KMC68EN360Al33L KMC68MH360VR33L MC68360Al25L MC68360Al25VL MC68360Al33L MC68360CAl25L MC68360CRC25L MC68360CVR25L MC68360CVR25LR2 MC68360CZQ25L MC68360CZQ25LR2 MC68360RC25L MC68360RC33L MC68360VR25L MC68360VR25LR2 MC68360VR25VL MC68360VR25VLR2 MC68360VR33L MC68360ZQ25L MC68360ZQ25LR2 MC68360ZQ25VL MC68360ZQ25VLR2 MC68360ZQ33L MC68E360VR25VLR2 MC68E360ZQ25VLR2 MC68EN360AI25L MC68EN360AI25VL MC68EN360AI33L MC68EN360CAI25L MC68EN360CRC25L MC68EN360CVR25L MC68EN360CVR33L MC68EN360CZQ25L MC68EN360CZQ33L MC68EN360RC25L MC68EN360RC33L MC68EN360VR25L MC68EN360VR25LR2 MC68EN360VR33L MC68EN360ZQ25L MC68EN360ZQ25LR2 MC68EN360ZQ25VL MC68EN360ZQ33L MC68M360VR25VLR2 MC68M360ZQ25VLR2 MC68MH360AI25L MC68MH360Al25VL MC68MH360Al33L MC68MH360CAl25L MC68MH360CVR25L MC68MH360CZQ25L MC68MH360RC25L MC68MH360RC33L MC68MH360VR25L MC68MH360VR25LR2 MC68MH360VR25VL MC68MH360VR33L MC68MH360VR33LR2 MC68MH360ZQ25L MC68MH360ZQ25LR2 MC68MH360ZQ25VL MC68MH360ZQ33L MC68MH360ZQ33LR2 MCE360CZQ25LR2 KMC68EN360RC33L KMC68EN360CAI25L KMC68360CAI25L KMC68EN360VR25VL KMC68MH360VR25VL KMC68MH360AI33L KMC68360AI33L KMC68MH360CAI25L KMC68MH360RC33L KMC68360VR33L KMC68MH360ZQ25VL KMC68EN360VR33L KMC68EN360ZQ25VL